

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Multilayer Directional Coupler

HHM Series

1608mm TYPE

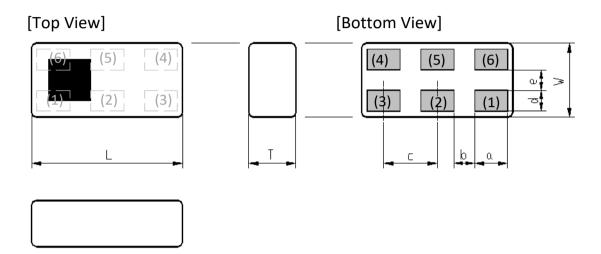
[mm]

P/N: **HHM22152A2**



HHM22152A2

SHAPES AND DIMENSIONS



Dimensions (mm)

L	W	Т	а	b	С	d	е
1.60	0.80	0.60	0.35	0.22	0.57	0.225	0.22
+/-0.05	+/-0.05	+/-0.05	+/-0.05	+/-0.05	+/-0.05	+/-0.05	+/-0.05

Terminal functions

(1)	Input Port
(2)	GND
(3)	Output Port
(4)	50ohm Termination
(5)	GND
(6)	Coupling Port

■ TERMINATION FINISH

Material
Au plate

• All specifications are subject to change without notice.



HHM22152A2

ELECTRICAL CHARACTERISTICS

(Measurement)

Parameter	Erogue) nov	(MHz)	TDK Spec.			
Parameter	rieque	ысу	(IVIITIZ)	Min.	Тур.	Max.	
	450	to	700	26.0	28.5	31.0	
Coupling Factor (dB)	700	to	2700	22.5	25.0	27.5	
	3400	to	3800	22.3	23.4	24.5	
Insertion Loss (dP)	450	to	2700	1	0.18	0.25	
Insertion Loss (dB)	3400	to	3800	1	0.32	0.40	
Isolation (dB)	450	to	2700	45	51.5	-	
isolation (db)	3400	to	3800	40	59.7	ı	
Return Loss(dB)	450	to	3800	10	15.0	-	
Characteristic Impedance (ohm)			·	50	(Nomi	nal)	

Ta = +25 + /-5°C

Coupler Type

<u> </u>	
Daisy Chain Available	Yes
Bi-Directional	No



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MAXIMUM RATINGS

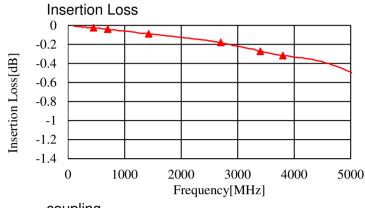
Parameter		TDK S	Spec	Conditions	
Parameter		Min.	Max.	Conditions	
Operating temperature (°C)		–40 to -	+85 °C		
Storage temperature (°C)			+85 °C		
Power Handling (W)		-	3	CW	
Human Body Model : HBM	@Each Port (V)	-1000	1000	100pF / 1500ohm	
Machine Model : MM	@Each Port (V)	-150	150	200pF / 0ohm	
Charged Device Model : CDM	@Each Port (V)	-500	500	Relative humidity : 51%RH max	

Ambient temperature: +25+/-5°C

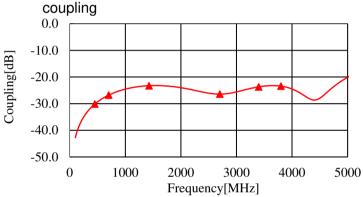


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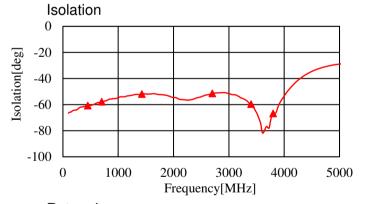
■ FREQUENCY CHARACTERISTICS



Frequency	
450 MHz	-0.02 dB
700 MHz	-0.04 dB
1427 MHz	-0.09 dB
2700 MHz	-0.18 dB
3400 MHz	-0.27 dB
3800 MHz	-0.32 dB



Frequency	
450 MHz	-30.2 dB
700 MHz	-26.8 dB
1427 MHz	-23.3 dB
2700 MHz	-26.4 dB
3400 MHz	-23.7 dB
3800 MHz	-23.4 dB



-60.7 dB
-57.8 dB
-51.9 dB
-51.5 dB
-59.7 dB
-66.8 dB

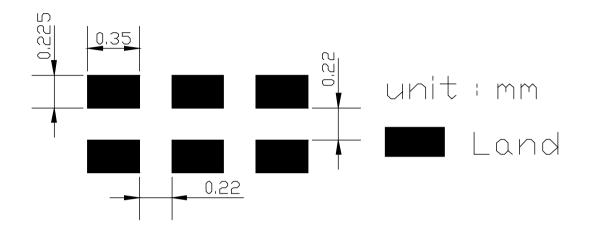
F		ı Los	S								
	0 -5										
	-10										
Return Loss[dB]	-15						-	_	_		
]ss[-20 -25										
Γ_0	-30				-/						
III	-35	~									
Seti	-20 -25 -30 -35 -40 -45 -50	/-									
_	-50										
	(0	10	00	20	00	30	00	40	00	5000
]	Frequ	ency	[MH	z]			

Frequency	
450 MHz	-39.3 dB
700 MHz	-40.6 dB
1427 MHz	-36.6 dB
2700 MHz	-20.1 dB
3400 MHz	-16.3 dB
3800 MHz	-15.0 dB

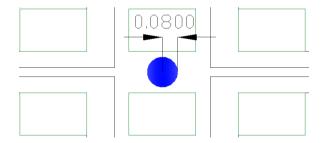


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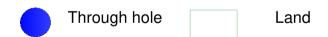
■ RECOMMENDED LAND PATTERN



Evaluation Board



^{*} Line width be designed to match 50ohm characteristic impedance, depending on PCB material and thickness.

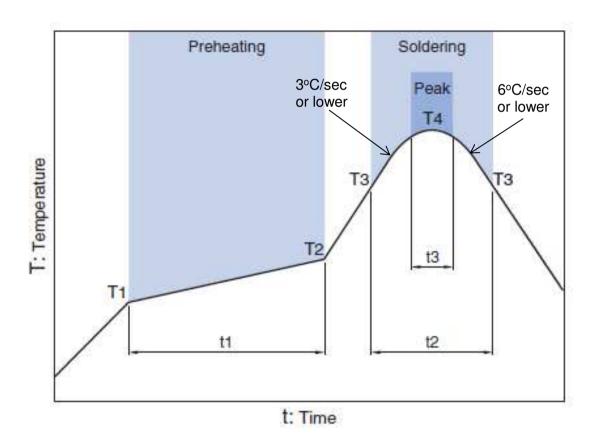


ENVIRONMENT INFORMATION

RoHS Statement RoHS Compliance

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RECOMMENDED REFLOW PROFILE



Droboating			Soldering						
Preheating			Critical zon	e (T3 to T4)	Peak				
Tei	Temp. Time		Temp.	Time	Temp.	Time			
T1	T2	t1	T3	t2	T4	t3 *			
150°C	200°C	60 to 120sec	217°C	60 to 120sec	240 to 260°C	30 sec Max			

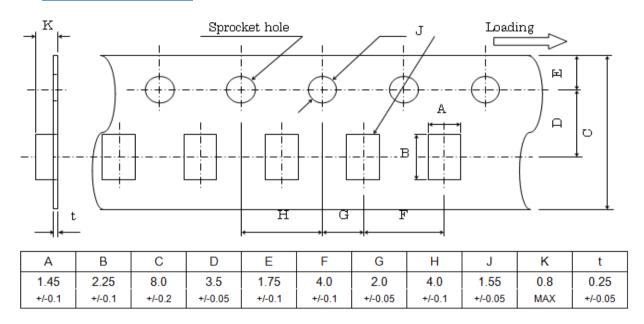
* t3 : Time within 5°C of actual peak temperature The maximum number of reflow is 3.

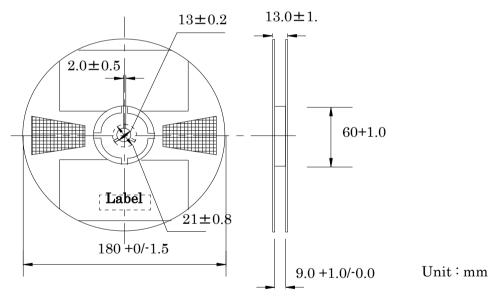
Note: Lead free solder is recommended.

Recommended solder is Sn-3.0Ag-0.5Cu. (M705 by Senju Metal Industry)

Oct.2017 Ver.4.1 TDK Corporation

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4000pcs./reel



REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

⚠ REMINDERS

The products listed on this specification sheet are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.

The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet.

- 1. Aerospace/Aviation equipment
- 2. Transportation equipment (cars, electric trains, ships, etc.)
- 3. Medical equipment
- 4. Power-generation control equipment
- 5. Atomic energy-related equipment
- 6. Seabed equipment
- 7. Transportation control equipment
- 8. Public information-processing equipment
- 9. Military equipment
- 10. Electric heating apparatus, burning equipment
- 11. Disaster prevention/crime prevention equipment
- 12. Safety equipment
- 13. Other applications that are not considered general-purpose applications

When using this product in general-purpose applications, you are kindly requested to take into consideration securing protection circuit/equipment or providing backup circuits, etc., to ensure higher safety.